



2SA2169/2SC6017 — PNP/NPN Epitaxial Planar Silicon Transistor

High-Current Switching Applications

Applications

- Relay drivers, lamp drivers, motor drivers

Features

- Adoption of MBIT processes
- Low collector-to-emitter saturation voltage
- Large current capacity
- High-speed switching

Specifications () : 2SA2169

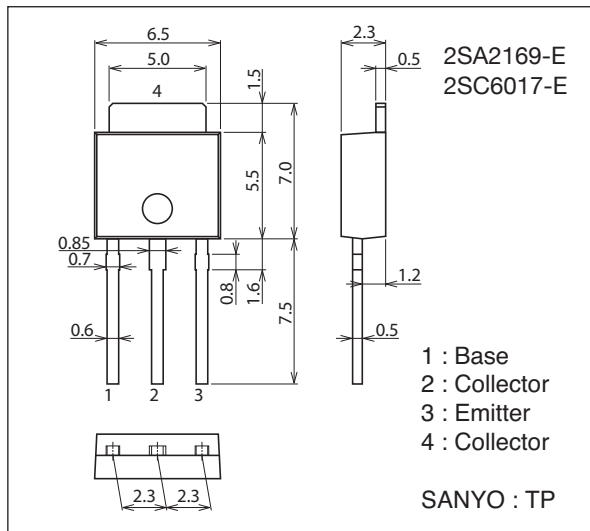
Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Conditions	Ratings	Unit
Collector-to-Base Voltage	V _{CB0}		(-50)100	V
Collector-to-Emitter Voltage	V _{CE0}		(-50)	V
Emitter-to-Base Voltage	V _{EB0}		(-6)	V
Collector Current	I _C		(-10)	A
Collector Current (Pulse)	I _{CP}	PW≤100μs	(-13)	A

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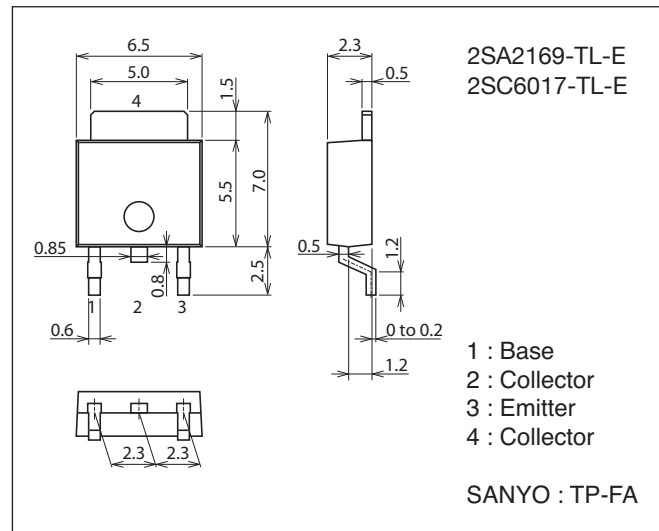
Package Dimensions unit : mm (typ)

7518-003



Package Dimensions unit : mm (typ)

7003-003

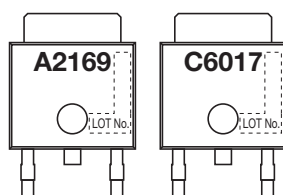


Product & Package Information

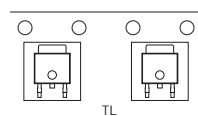
- Package : TP
- JEITA, JEDEC : SC-64, TO-251
- Minimum Packing Quantity : 500 pcs./bag

- Package : TP-FA
- JEITA, JEDEC : SC-63, TO-252
- Minimum Packing Quantity : 700 pcs./reel

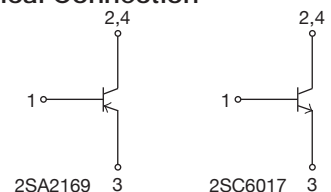
Marking (TP, TP-FA)



Packing Type (TP-FA) : TL



Electrical Connection



2SA2169/2SC6017

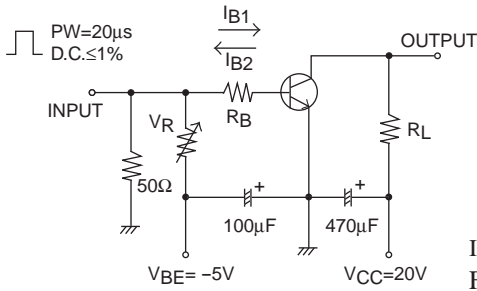
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Parameter	Symbol	Conditions	Ratings	Unit
Base Current	I_B		(-) 2	A
Collector Dissipation	P_C		0.95	W
		$T_C=25^\circ\text{C}$	20	W
Junction Temperature	T_j		150	$^\circ\text{C}$
Storage Temperature	T_{stg}		-55 to $+150$	$^\circ\text{C}$

Electrical Characteristics at $T_a=25^\circ\text{C}$

Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	
Collector Cutoff Current	I_{CBO}	$V_{CB}=(-)40\text{V}, I_E=0\text{A}$			$(-)10$	μA
Emitter Cutoff Current	I_{EBO}	$V_{EB}=(-)4\text{V}, I_C=0\text{A}$			$(-)10$	μA
DC Current Gain	h_{FE}	$V_{CE}=(-)2\text{V}, I_C=(-)1\text{A}$	200		$(560)700$	
Gain-Bandwidth Product	f_T	$V_{CE}=(-)5\text{V}, I_C=(-)1\text{A}$		$(130)200$		MHz
Output Capacitance	C_{ob}	$V_{CB}=(-)10\text{V}, f=1\text{MHz}$		$(90)60$		pF
Collector-to-Emitter Saturation Voltage	$V_{CE(sat)}$	$I_C=(-)5\text{A}, I_B=(-)250\text{mA}$	$(-290)180$		$(-580)360$	mV
Base-to-Emitter Saturation Voltage	$V_{BE(sat)}$	$I_C=(-)5\text{A}, I_B=(-)250\text{mA}$	$(-)0.93$		$(-)1.4$	V
Collector-to-Base Breakdown Voltage	$V_{(BR)CBO}$	$I_C=(-)100\mu\text{A}, I_E=0\text{A}$	$(-50)100$			V
Collector-to-Emitter Breakdown Voltage	$V_{(BR)CEO}$	$I_C=(-)1\text{mA}, R_{BE}=\infty$	$(-)50$			V
Emitter-to-Base Breakdown Voltage	$V_{(BR)EBO}$	$I_E=(-)100\mu\text{A}, I_C=0\text{A}$	$(-)6$			V
Turn-On Time	t_{on}	See specified Test Circuit.		$(70)40$		ns
Storage Time	t_{stg}			$(650)1000$		ns
Fall Time	t_f			$(60)80$		ns

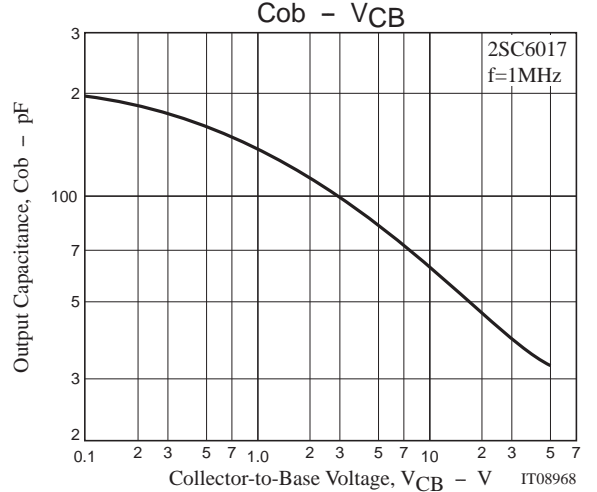
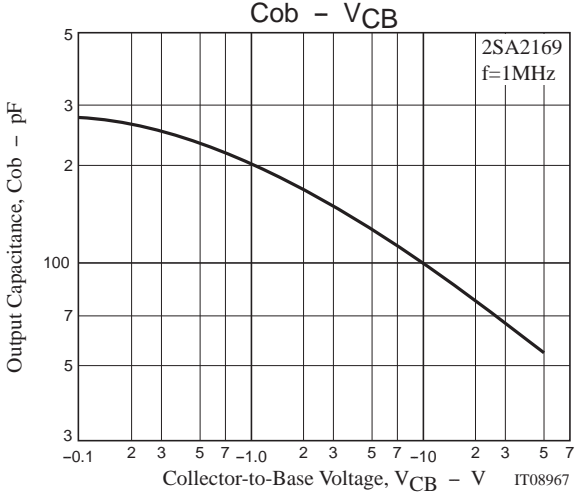
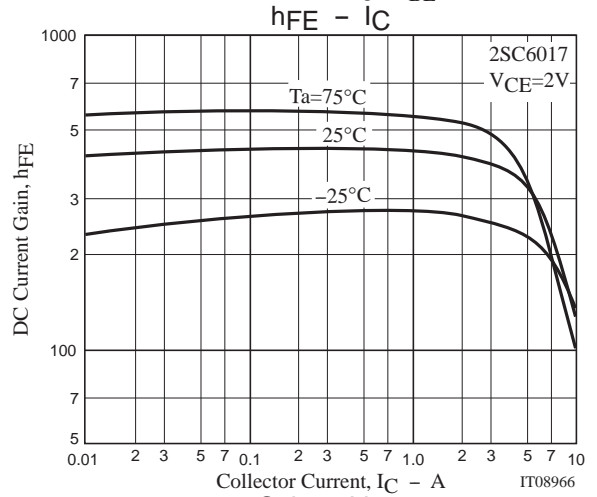
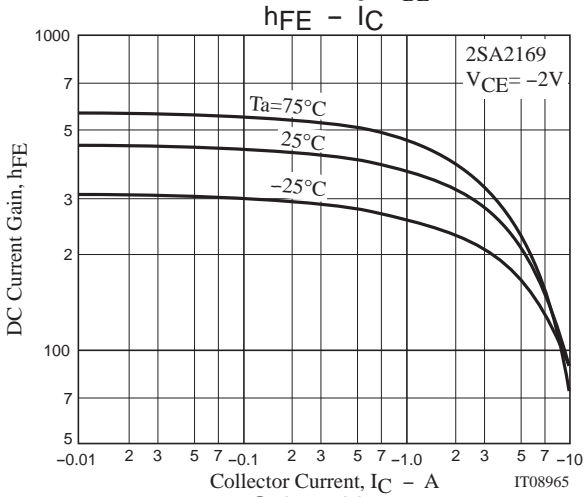
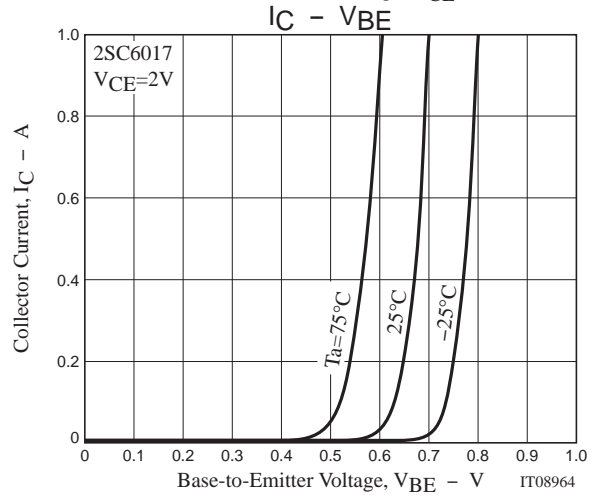
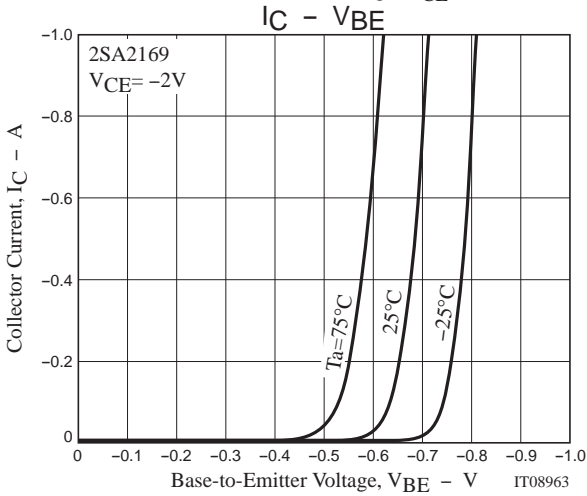
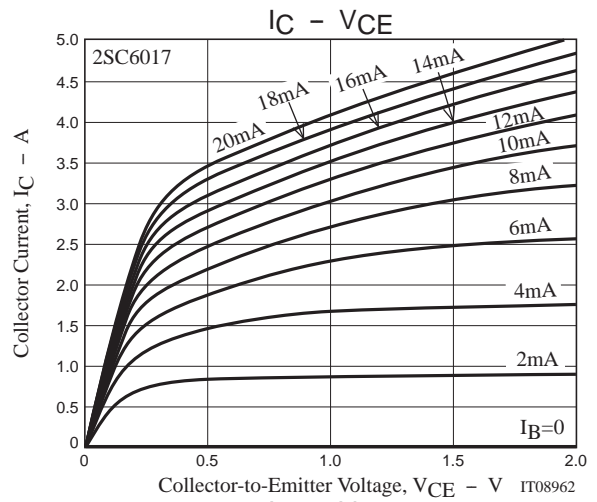
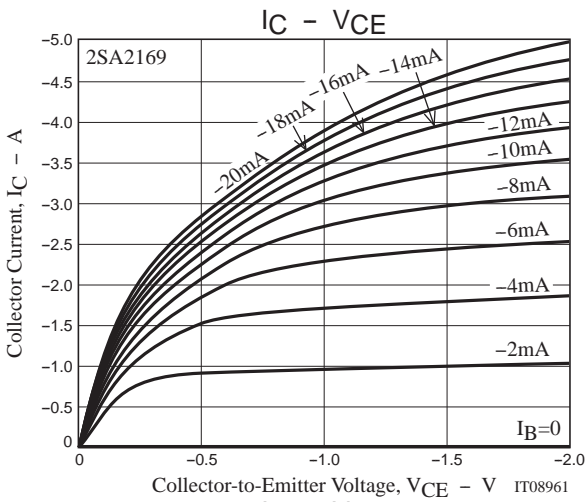
Switching Time Test Circuit



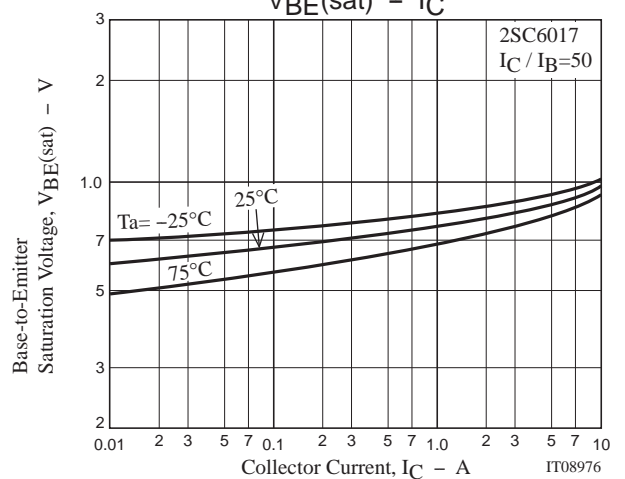
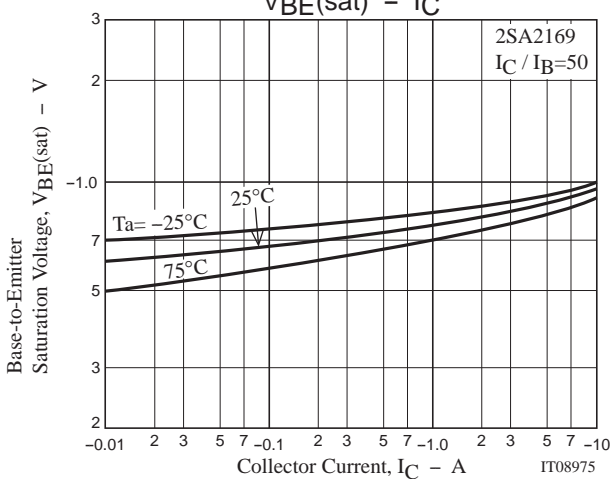
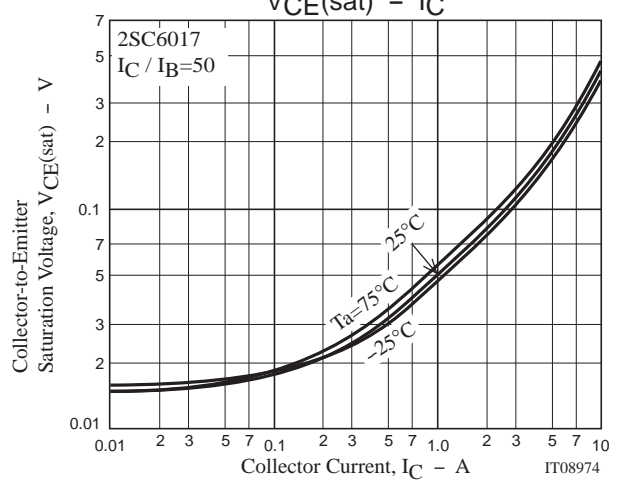
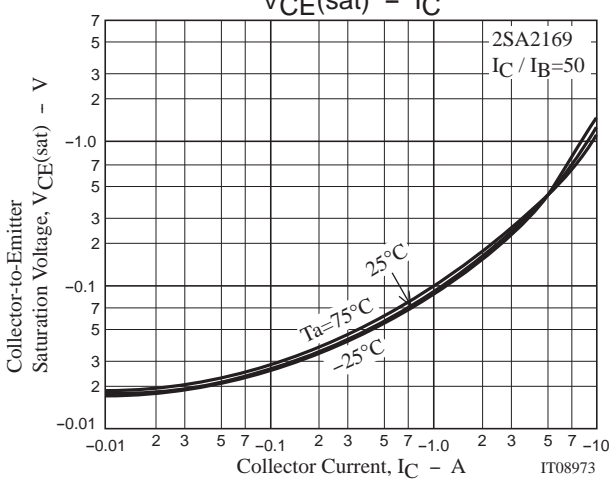
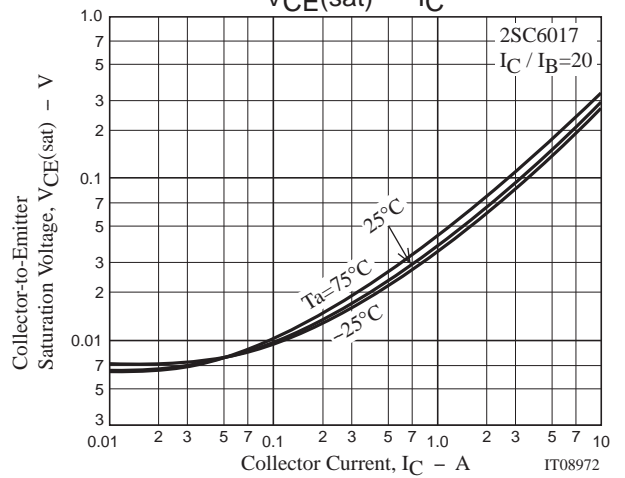
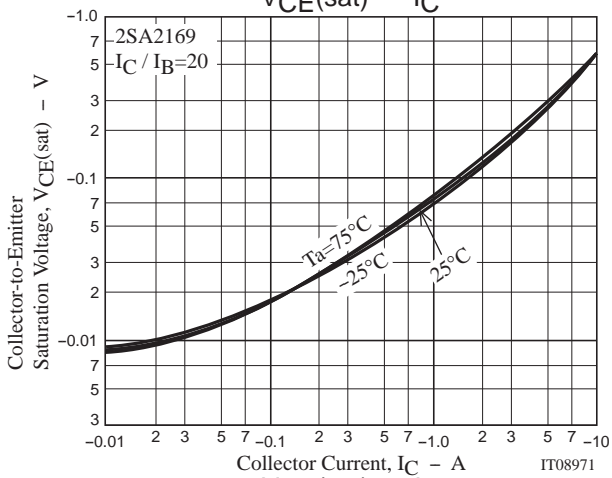
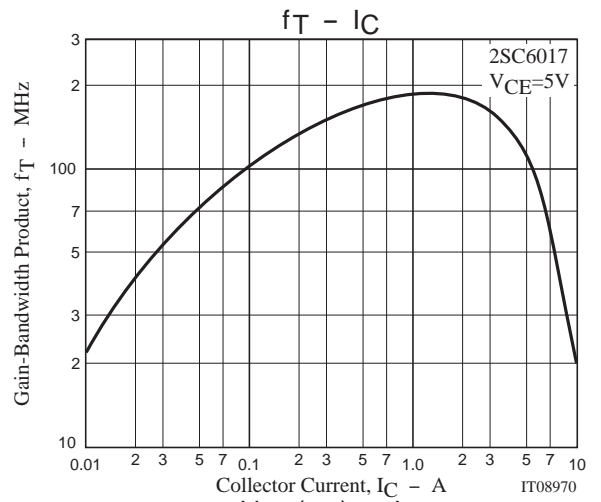
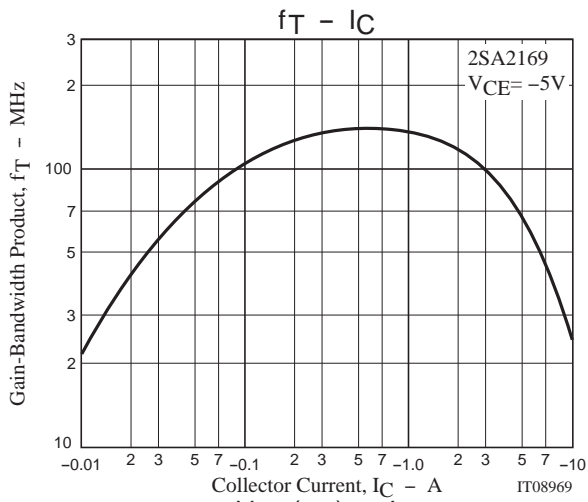
$I_C=20I_{B1} = -20I_{B2}=3\text{A}$
For PNP, the polarity is reversed.

Ordering Information

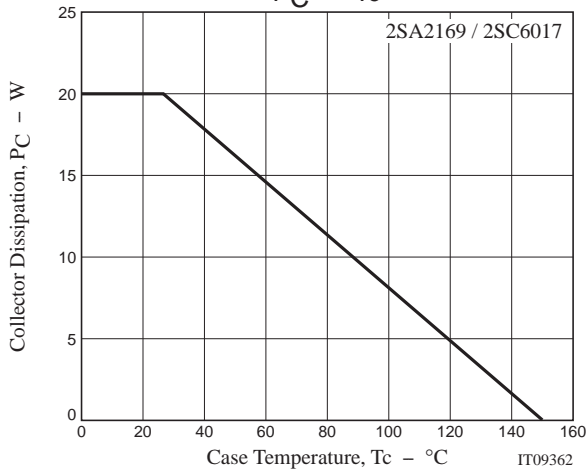
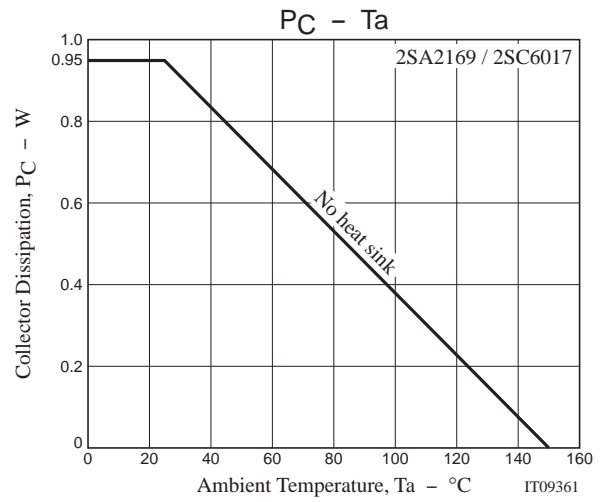
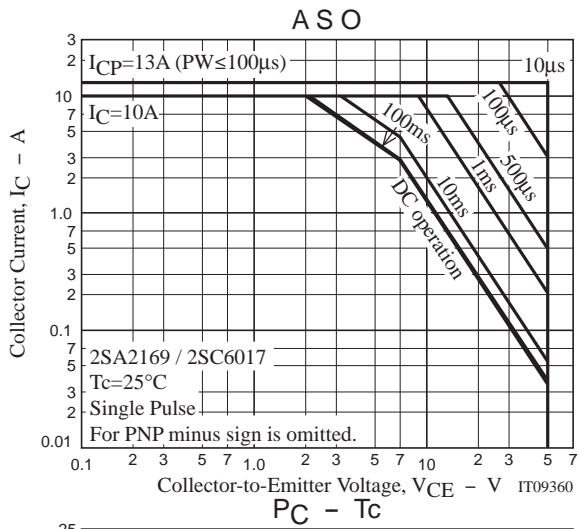
Device	Package	Shipping	memo
2SA2169-E	TP	500pcs./bag	Pb Free
2SC6017-E	TP	500pcs./bag	
2SA2169-TL-E	TP-FA	700pcs./reel	
2SC6017-TL-E	TP-FA	700pcs./reel	



2SA2169/2SC6017



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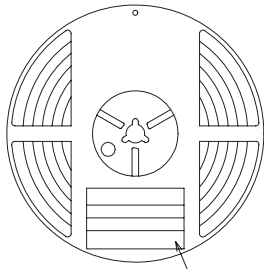
Taping Specification

2SA2169-TL-E, 2SC6017-TL-E

Packing Format

Package Name	Carrier Tape Type	Maximum Number of devices contained (pcs)			Packing format	
		Reel	Inner box	Outer box	Inner BOX (C-1)	Outer BOX (A-7)
TP-FA	TP	700	2,100	12,600	3 reels contained Dimensions:mm (external) 183×72×185	6 inner boxes contained Dimensions:mm (external) 440×195×210

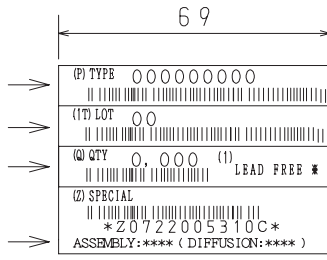
Packing method



Type No.
LOT No.
Quantity
Origin

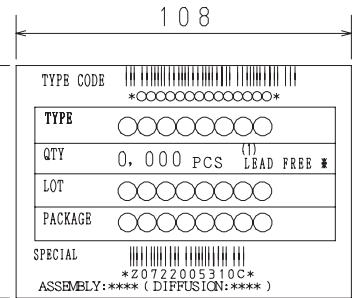
Reel label

Reel label, Inner box label (unit:mm)



Outer box label

It is a label at the time of factory shipments. The form of a label may change in physical distribution process.



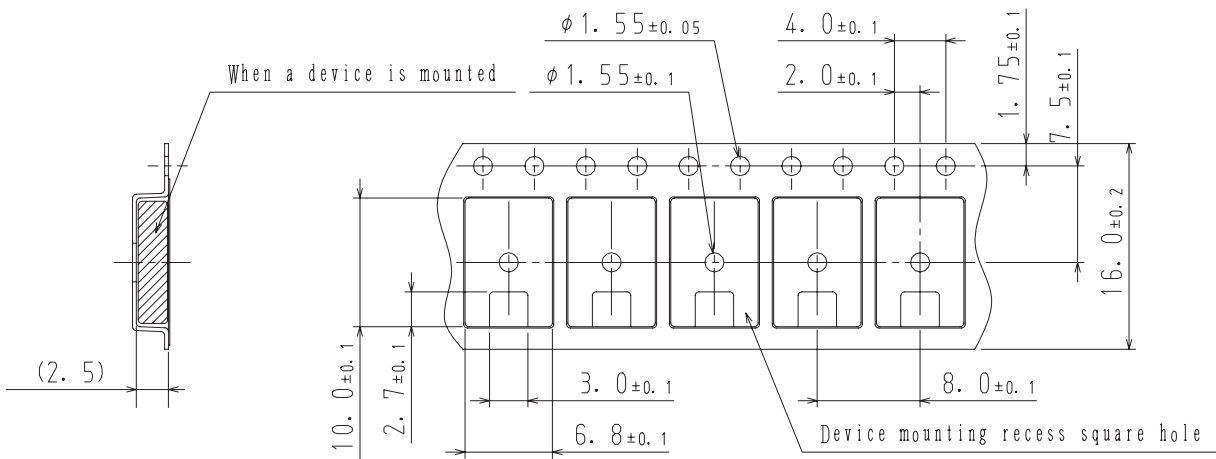
NOTE (1)

The LEAD FREE * description shows that the surface treatment of the terminal is lead free.

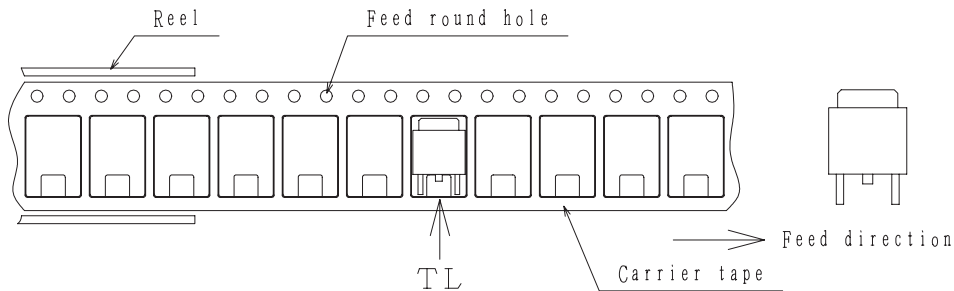
Label	JEITA Phase
LEAD FREE 3	JEITA Phase 3A
LEAD FREE 4	JEITA Phase 3

Taping configuration

1. Carrier tape size (unit:mm)



2. Device placement direction

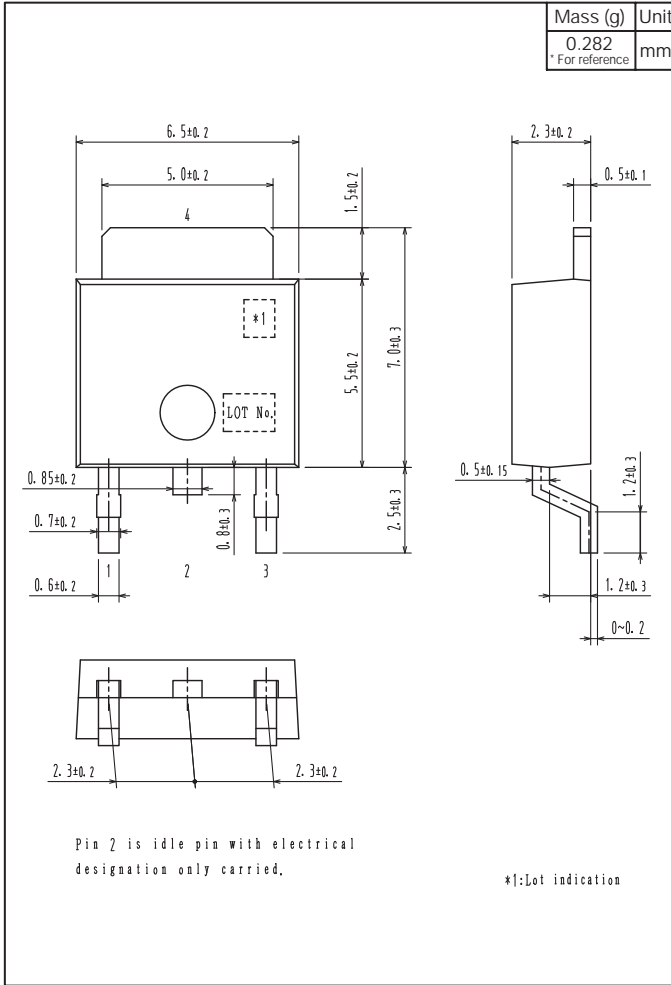


Those with one electrode terminal on the feed hole side.....TL

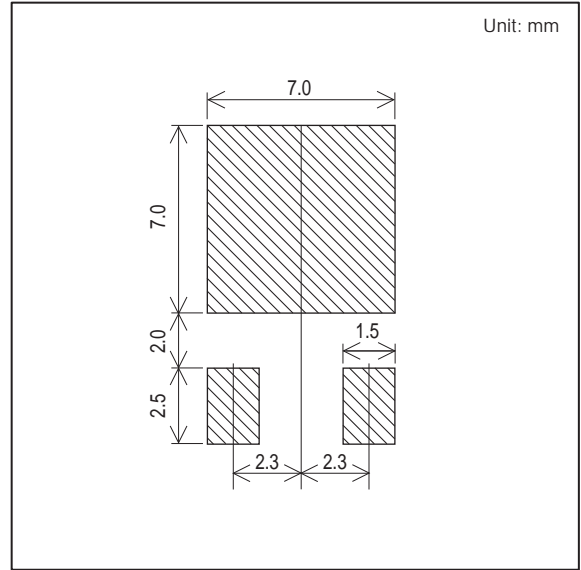
2SA2169/2SC6017

Outline Drawing

2SA2169-TL-E, 2SC6017-TL-E



Land Pattern Example



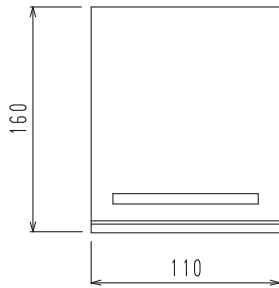
Bag Packing Specification

2SA2169-E, 2SC6017-E

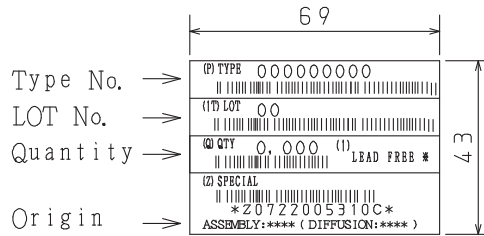
1. Packing Format

Package Name	Maximum Number of devices contained (pcs)			
	Bag	Inner box	Outer box	
TP	500	B-1	A-1	A-2
		10,000	50,000	30,000
	Packing format (Dimensions:mm (external))			
		Inner box	Outer box	
		B-1	A-1	A-2
		445×225×55	470×250×300	470×250×190

2. Bag dimensions
(unit:mm)



3. Bag label, Inner box label
(unit:mm)



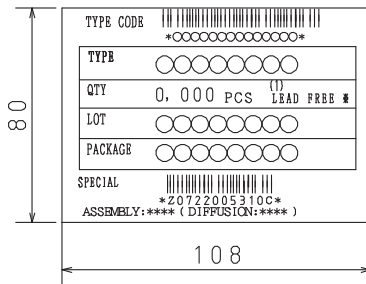
4. Outer box label
(unit:mm)

It is a label at the time of factory shipments.
The form of a label may change in physical distribution process.

NOTE (1)

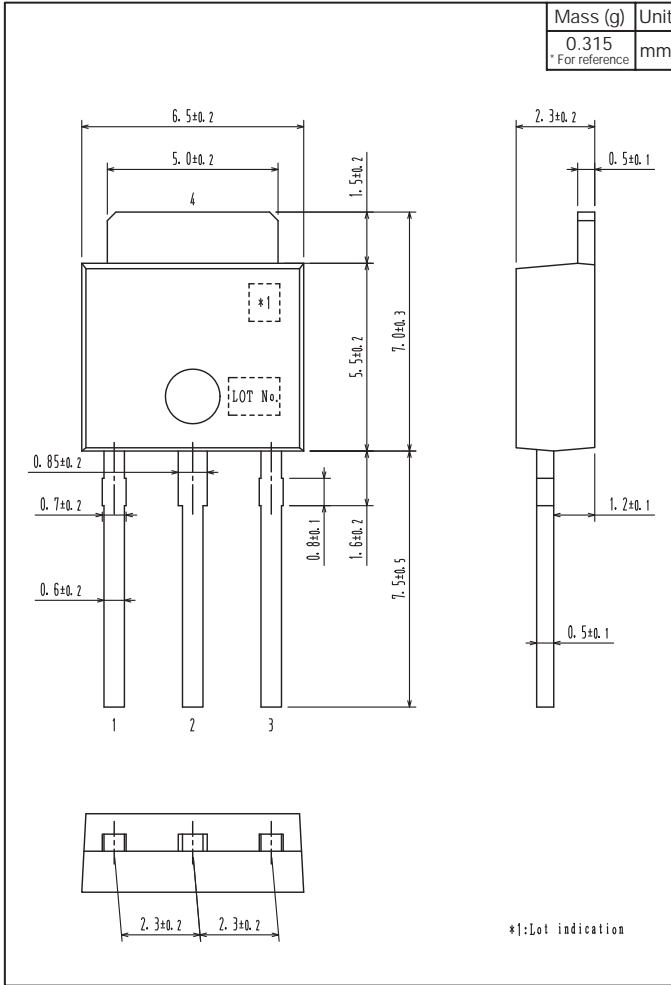
The LEAD FREE * description shows that the surface treatment of the terminal is lead free.

Label	JEITA Phase
LEAD FREE 3	JEITA Phase 3A
LEAD FREE 4	JEITA Phase 3



Outline Drawing

2SA2169-E, 2SC6017-E



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